

MOSFET

StrongIRFET™2 Power-Transistor, 30 V

Features

- Optimized for a wide range of applications
- N-channel, logic level
- 100% avalanche tested
- 175°C rated
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

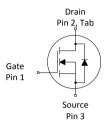
Product validation

Qualified according to JEDEC Standard

Table 1 Key Performance Parameters

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Parameter		Value	Unit
$V_{ m DS}$		30	V
$R_{\rm DS(on),max}$		2.05	mΩ
I _D		125	А
$Q_{\rm oss}$		54	nC
Q _G (0V4.5V)		33	nC









Type/Ordering Code	Package	Marking	Related Links
IPP020N03LF2S	PG-TO220-3	020N03F2	-

Public

StrongIRFET™2 Power-Transistor, 30 V IPP020N03LF2S



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StrongIRFET™2 Power-Transistor, 30 V IPP020N03LF2S



1 Maximum ratings

at T_{Δ} =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note/ Test Condition
raianietei	Syllibot	Min.	Тур.	Max.	Offic	Note/ Test Condition
Continuous drain current ¹⁾	I _D	-	-	125 97 33	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	500	А	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	338 676	mJ	I_D =70 A, R_{GS} =25 Ω I_D =35 A, R_{GS} =25 Ω
Gate source voltage	V_{GS}	-20	-	20	V	-
Power dissipation	P_{tot}	-	-	136 3.8	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ²⁾
Operating and storage temperature	$T_{\rm j}$, $T_{\rm stg}$	-55	-	175	°C	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

StronglRFET™2 Power-Transistor, 30 V IPP020N03LF2S



2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailletei	Symbol	Min.	Тур.	Мах.	Offic	Note, rest condition
Thermal resistance, junction - case	R_{thJC}	-	-	1.1	°C/W	-
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R_{thJA}	-	-	62	°C/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

StrongIRFET™2 Power-Transistor, 30 V IPP020N03LF2S



3 Electrical characteristics

at T_i =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailletei	Syllibot	Min.	Тур.	Мах.	Oilit	Note/ Test Condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	30	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =2 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.35	1.85	2.35	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 80 \ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =30 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =30 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Drain-source on-state resistance ⁶⁾	$R_{\mathrm{DS(on)}}$	-	1.76 2.1	2.05 3.0	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =70 A $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =35 A
Gate resistance	R_{G}	-	2.3	-	Ω	-
Transconductance ⁷⁾	g_{fs}	100	-	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D}=70 \text{ A}$

⁶⁾ R_{DS(on)} is specified at a distance of 1.8 mm distance to the package body; mounting at a larger distance increases the overall package resistance of approximately 0.04 mOhm/mm per leg.

Table 5 Dynamic characteristics

Davamakar	Cymahal	Values			llmit	Nieto/Tost Condition
Parameter	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Input capacitance	C _{iss}	-	4700	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	910	-	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =15 V, f =1 MHz
Reverse transfer capacitance	C _{rss}	-	235	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{d(on)}$	-	22	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =70 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	70	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =70 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	28	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =70 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	_	13	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =70 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailietei	Syllibot	Min.	Тур.	Мах.	Offic	Note/ rest condition
Gate to source charge	$Q_{ m gs}$	-	15	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =70 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	8.6	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =70 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge	Q_{gd}	-	10	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =70 A, $V_{\rm GS}$ =0 to 4.5 V

⁷⁾ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailletei	Symbol	Min.	Тур.	Мах.		Note/ Test Condition
Switching charge	Q_{sw}	-	17	-	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =70 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ⁹⁾	$Q_{ m g}$	-	33	50	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =70 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	$V_{ m plateau}$	-	3.3	-	V	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =70 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ⁹⁾	Q_{g}	-	69	104	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =70 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET ⁹⁾	$Q_{g(sync)}$	-	29	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 4.5 V
Output charge ⁹⁾	$Q_{\rm oss}$	-	54	-	nC	V _{DS} =15 V, V _{GS} =0 V

⁸⁾ See "Gate charge waveforms" for parameter definition

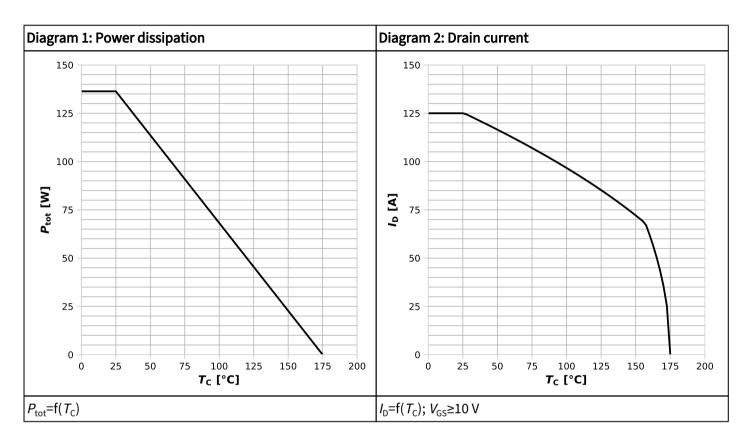
Table 7 Reverse diode

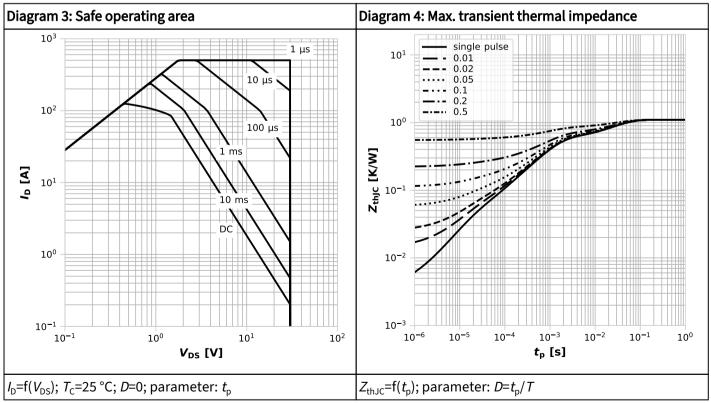
Parameter	Symbol	Values			Unit	Nata/Tast Condition
rarameter	Symbol	Min.	Тур.	Мах.	Ollic	Note/ Test Condition
Diode continuous forward current	I _s	-	-	96	А	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	500	А	<i>T</i> _c =25 °C
Diode forward voltage	$V_{\rm SD}$	-	0.85	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =70 A, $T_{\rm j}$ =25 °C
Reverse recovery time	t _{rr}	-	20	-	ns	$V_{\rm R}$ =15 V, $I_{\rm F}$ =70 A, d $i_{\rm F}$ /d t =500 A/ μ s
Reverse recovery charge	$Q_{\rm rr}$	-	63	-	nC	$V_{\rm R}$ =15 V, $I_{\rm F}$ =70 A, d $I_{\rm F}$ /d t =500 A/ μ s

⁹⁾ Defined by design. Not subject to production test.

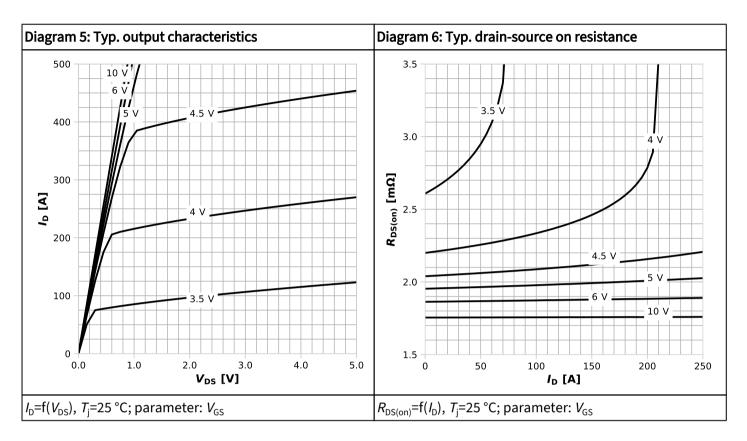


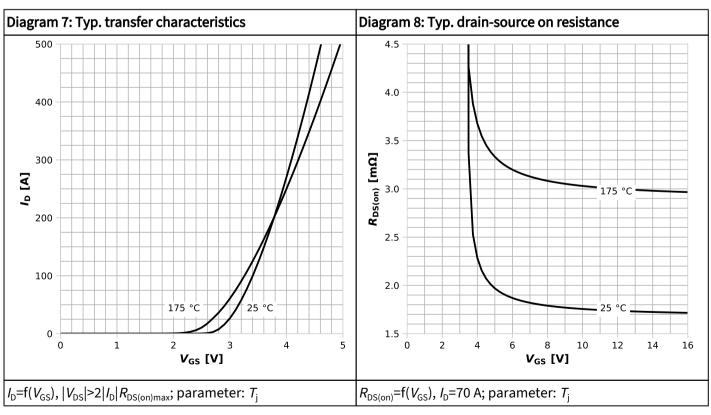
4 Electrical characteristics diagrams



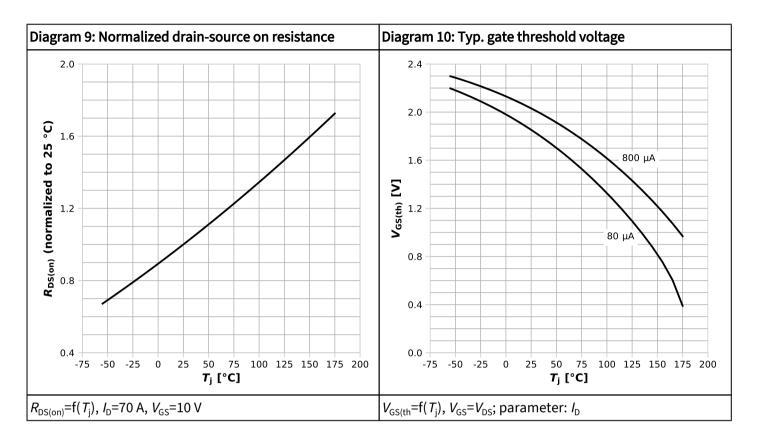


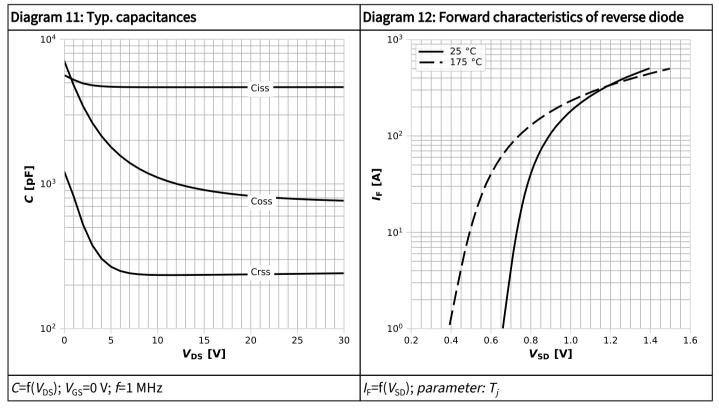




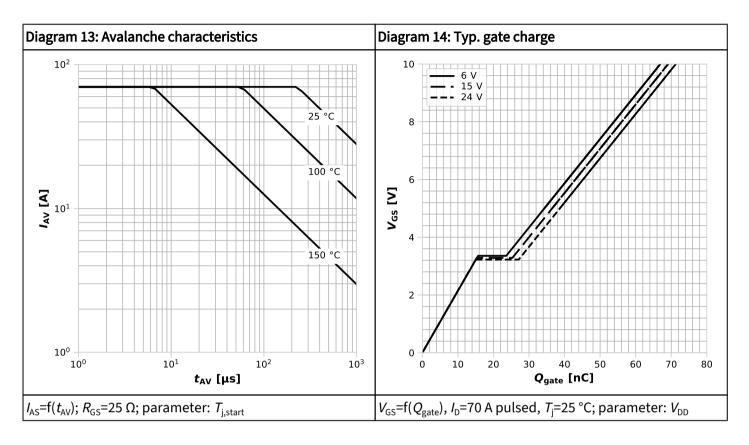


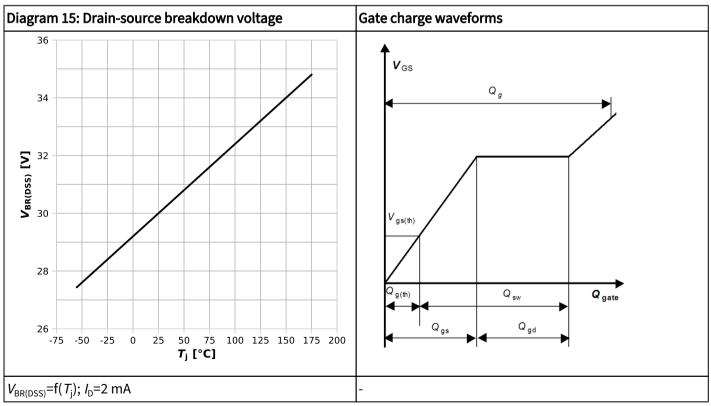














5 Package Outlines

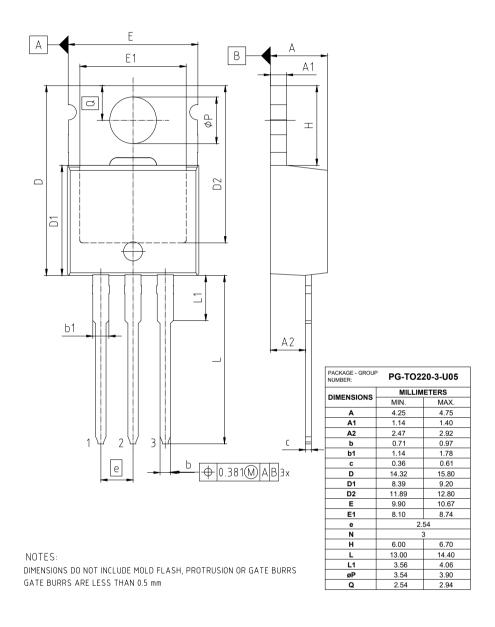


Figure 1 Outline PG-TO220-3, dimensions in mm

StronglRFET™2 Power-Transistor, 30 V IPP020N03LF2S



Revision History

IPP020N03LF2S

Revision 2024-05-29, Rev. 2.1

Previous Revision

Revision Date Subjects (major changes since last revision)					
2.0	2024-05-24	Release of final			
2.1	2024-05-29	Updated typo in Product Validation			

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